

NX3008NBKS

30 V, 350 mA dual N-channel Trench MOSFET Rev. 1 — 1 August 2011

Product data sheet

Product profile 1.

1.1 General description

Dual N-channel enhancement mode Field-Effect Transistor (FET) in a very small SOT363 (SC-88) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

1.2 Features and benefits

- Very fast switching
- Low threshold voltage
- Trench MOSFET technology
- ESD protection up to 2 kV
- AEC-Q101 qualified

1.3 Applications

- Relay driver
- High-speed line driver

- Low-side loadswitch
- Switching circuits

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transis	tor					
V_{DS}	drain-source voltage	T _j = 25 °C	-	-	30	V
V_{GS}	gate-source voltage		-8	-	8	V
I_D	drain current	$V_{GS} = 4.5 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}$	<u>[1]</u> _	-	350	mA
Static char	Static characteristics (per transistor)					
R _{DSon}	drain-source on-state resistance	$V_{GS} = 4.5 \text{ V}; I_D = 350 \text{ mA};$ $T_j = 25 \text{ °C}$	-	1	1.4	Ω

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 1 cm².



2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S1	source TR1	D. D. D.	D
2	G1	gate TR1	<u> </u>	D1 D2
3	D2	drain TR2		
4	S2	source TR2	0	G1 $G2$
5	G2	gate TR2	□1 □2 □3	
6	D1	drain TR1	SOT363 (SC-88)	14 23
				S1 S2 017aaa256

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
NX3008NBKS	SC-88	plastic surface-mounted package; 6 leads	SOT363

4. Marking

Table 4. Marking codes

Type number	Marking code ^[1]
NX3008NBKS	LB%

^{[1] % =} placeholder for manufacturing site code.

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per transistor						
V_{DS}	drain-source voltage	T _j = 25 °C		-	30	V
V_{GS}	gate-source voltage			-8	8	V
I _D	drain current	$V_{GS} = 4.5 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}$	<u>[1]</u>	-	350	mA
		V _{GS} = 4.5 V; T _{amb} = 100 °C	<u>[1]</u>	-	230	mA
I _{DM}	peak drain current	$T_{amb} = 25$ °C; single pulse; $t_p \le 10 \mu s$		-	1.4	Α
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	280	mW
			<u>[1]</u>	-	320	mW
		T _{sp} = 25 °C		-	990	mW
Per device						
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	445	mW
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
Source-drain diode						
I _S	source current	T _{amb} = 25 °C		-	300	mA
ESD maximum	ESD maximum rating					
V _{ESD}	electrostatic discharge voltage	НВМ	[3]	-	2000	V

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 1 cm².

^[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

^[3] Measured between all pins.

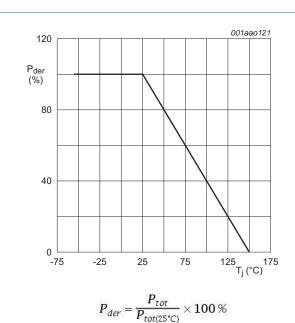


Fig 1. Normalized total power dissipation as a function of junction temperature

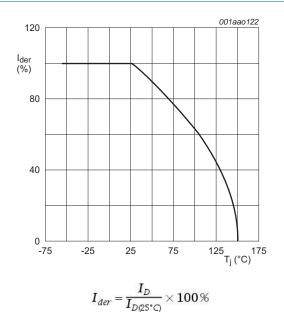
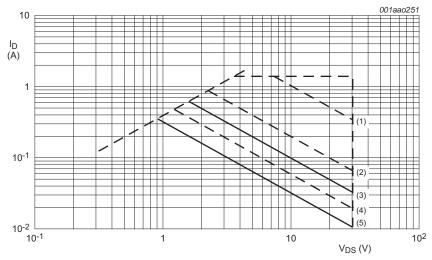


Fig 2. Normalized continuous drain current as a function of junction temperature



 I_{DM} is a single pulse

- (1) $t_p = 1 \text{ ms}$
- (2) $t_p = 10 \text{ ms}$
- (3) DC; $T_{sp} = 25 \, ^{\circ}\text{C}$
- (4) $t_p = 100 \text{ ms}$
- (5) DC; $T_{amb} = 25 \text{ °C}$; 1 cm² drain mounting pad

Fig 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage

6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transistor						
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	390	445	K/W
			[2] _	340	390	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	130	K/W
Per device						
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	300	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm².

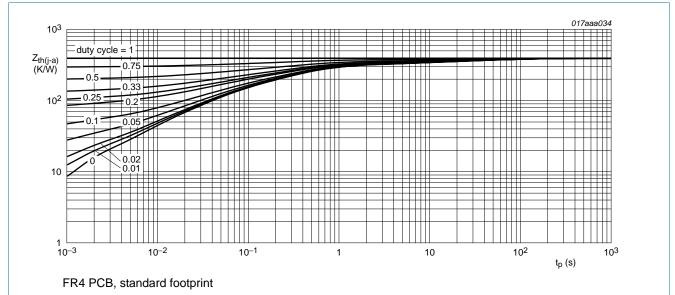


Fig 4. Per transistor: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

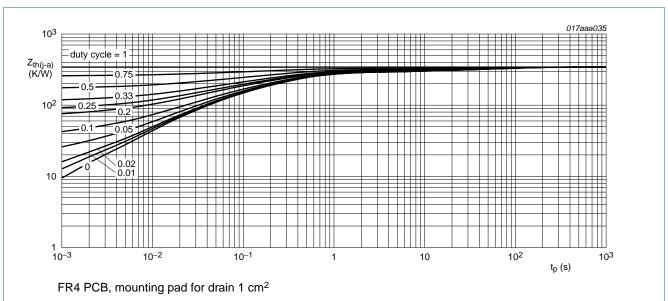


Fig 5. Per transistor: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

7. Characteristics

Table 7. Characteristics

Table 7.	Juanacieristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics (per transistor)					
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25 °C$	30	-	-	V
V_{GSth}	gate-source threshold voltage	$I_D = 250 \mu A; V_{DS} = V_{GS}; T_j = 25 \text{ °C}$	0.6	0.9	1.1	V
I _{DSS}	drain leakage current	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	1	μΑ
		$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 \text{ °C}$	-	-	10	μΑ
I _{GSS}	gate leakage current	$V_{GS} = 8 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.2	1	μΑ
		$V_{GS} = -8 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.2	1	μΑ
		$V_{GS} = 4.5 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	10	-	nΑ
		$V_{GS} = -4.5 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	10	-	nΑ
		$V_{GS} = 2.5 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	1	-	nΑ
		$V_{GS} = -2.5 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	1	-	nΑ
R_{DSon}	drain-source on-state	$V_{GS} = 4.5 \text{ V}; I_D = 350 \text{ mA}; T_j = 25 \text{ °C}$	-	1	1.4	Ω
	resistance	$V_{GS} = 4.5 \text{ V}; I_D = 350 \text{ mA}; T_j = 150 \text{ °C}$	-	1.8	2.5	Ω
		V_{GS} = 2.5 V; I_D = 200 mA; T_j = 25 °C	-	1.4	2.1	Ω
		V_{GS} = 1.8 V; I_D = 10 mA; T_j = 25 °C	-	2	2.8	Ω
9 _{fs}	forward transconductance	$V_{DS} = 10 \text{ V}; I_D = 350 \text{ mA}; T_j = 25 \text{ °C}$	-	310	-	mS
Dynamic ch	aracteristics (per transist	or)				
$Q_{G(tot)}$	total gate charge	$V_{DS} = 15 \text{ V}; I_D = 350 \text{ mA}; V_{GS} = 4.5 \text{ V};$	-	0.52	0.68	nC
Q_{GS}	gate-source charge	T _j = 25 °C	-	0.17	-	nC
Q_{GD}	gate-drain charge		-	0.08	-	nC
C _{iss}	input capacitance	$V_{DS} = 15 \text{ V}; f = 1 \text{ MHz}; V_{GS} = 0 \text{ V};$	-	34	50	pF
C_{oss}	output capacitance	T _j = 25 °C	-	6.5	-	pF
C _{rss}	reverse transfer capacitance		-	2.2	-	pF
d(on)	turn-on delay time	V_{DS} = 20 V; R_L = 250 Ω ; V_{GS} = 4.5 V;	-	15	30	ns
r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	11	-	ns
d(off)	turn-off delay time		-	69	138	ns
: f	fall time		-	19	-	ns
Source-drai	n diode (per transistor)					
V _{SD}	source-drain voltage	$I_S = 350 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	0.47	0.85	1.2	V

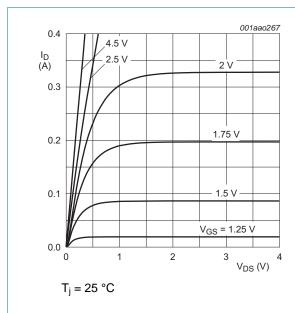
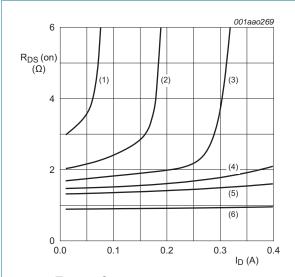


Fig 6. Output characteristics: drain current as a function of drain-source voltage; typical values



 $T_j = 25 \, ^{\circ}C$

(1) $V_{GS} = 1.5 \text{ V}$

(2) $V_{GS} = 1.75 \text{ V}$

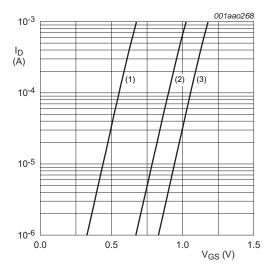
(3) $V_{GS} = 2.0 \text{ V}$

(4) $V_{GS} = 2.25 \text{ V}$

(5) $V_{GS} = 2.5 \text{ V}$

(6) $V_{GS} = 4.5 \text{ V}$

Fig 8. Drain-source on-state resistance as a function of drain current; typical values



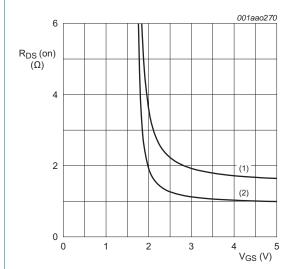
 $T_{j} = 25 \, ^{\circ}C; \, V_{DS} = 5 \, V$

(1) minimum values

(2) typical values

(3) maximum values

Fig 7. Sub-threshold drain current as a function of gate-source voltage



 $I_D = 350 \text{ mA}$

(1) $T_i = 150 \, ^{\circ}C$

(2) $T_i = 25 \, ^{\circ}C$

Fig 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

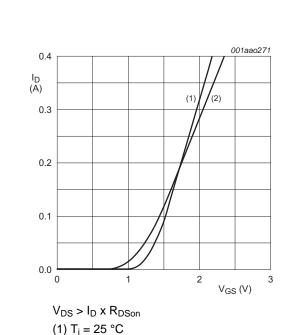


Fig 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

(2) $T_i = 150 \, ^{\circ}\text{C}$

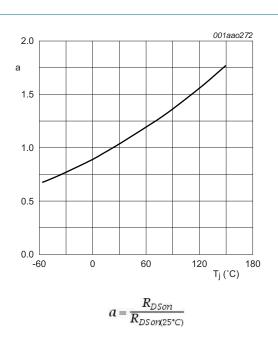
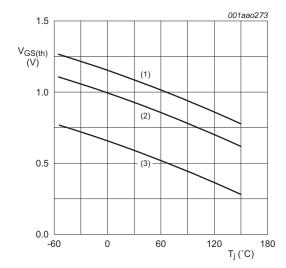


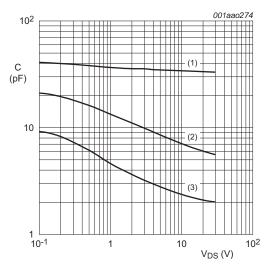
Fig 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values



 $I_D = 0.25 \text{ mA}; V_{DS} = V_{GS}$

- (1) maximum values
- (2) typical values
- (3) minimum values

Fig 12. Gate-source threshold voltage as a function of junction temperature



 $f = 1 MHz; V_{GS} = 0 V$

(1)C_{iss}

(2)Coss

(3)C_{rss}

Fig 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

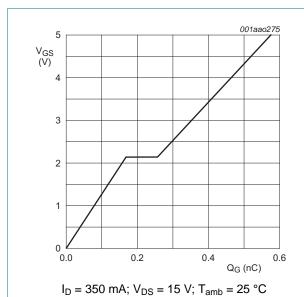


Fig 14. Gate-source voltage as a function of gate charge; typical values

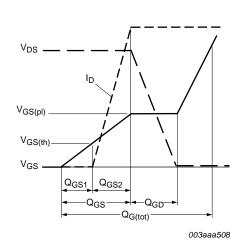
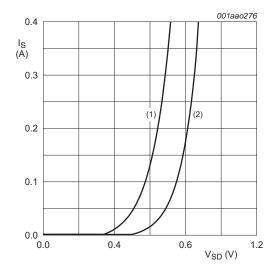


Fig 15. Gate charge waveform definitions



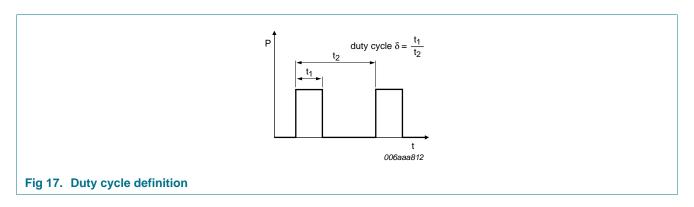
 $V_{GS} = 0 V$

(1) $T_j = 150 \, ^{\circ}\text{C}$

(2) $T_j = 25 \, ^{\circ}C$

Fig 16. Source current as a function of source-drain voltage; typical values

8. Test information



8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline

Plastic surface-mounted package; 6 leads **SOT363** Α X = v M A ⊕ w M B е detail X **DIMENSIONS (mm are the original dimensions)** Α1 UNIT Α D Ε С Q v е HΕ Lp w у max 0.30 0.25 1.35 0.45 0.25 1.1 2.2 2.2 0.65 0.1 1.8 2.0 0.20 0.10 8.0 1.15 0.15 0.15 **REFERENCES EUROPEAN** OUTLINE ISSUE DATE VERSION **PROJECTION** IEC JEDEC **JEITA**

Fig 18. Package outline SOT363 (SC-88)

NX3008NBKS

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SC-88

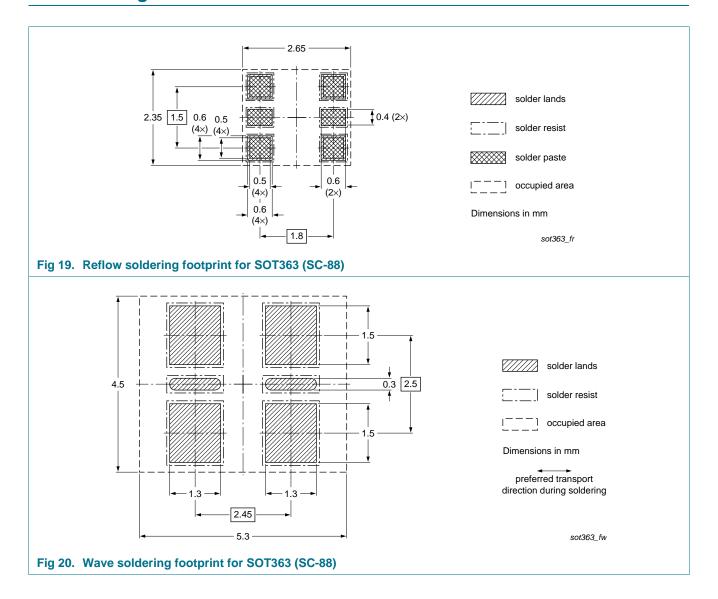
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SOT363

10. Soldering



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30 V, 350 mA dual N-channel Trench MOSFET

11. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3008NBKS v.1	20110801	Product data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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